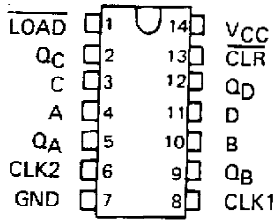
SN54176, SN54177, SN74176, SN74177
35-MHz PRESETTABLE DECADE AND BINARY COUNTERS/LATCHES

MAY 1971—REVISED MARCH 1988

- Reduced-Power Versions of SN54196, SN54197, SN74196, and SN74197 50-MHz Counters
- D-C Coupled Counters Designed to Replace Signetics 8280, 8281, 8290, and 8291 Counters In Most Applications
- Performs BCD, Bi-Quinary, or Binary Counting
- Fully Programmable
- Fully Independent Clear Input
- Counts at Input Frequencies from 0 to 35 MHz
- Input Clamping Diodes Simplify System Design

SN54176, SN54177 . . . J PACKAGE
SN74176, SN74177 . . . N PACKAGE
(TOP VIEW)



description

These high-speed monolithic counters consist of four d-c coupled master-slave flip-flops which are internally interconnected to provide either a divide-by-two and a divide-by-five counter (SN54176, SN74176) or a divide-by-two and a divide-by-eight counter (SN54177, SN74177). These counters are fully programmable; that is, the outputs may be preset to any state by placing a low on the count/load input and entering the desired data at the data inputs. The outputs will change to agree with the data inputs independent of the state of the clocks.

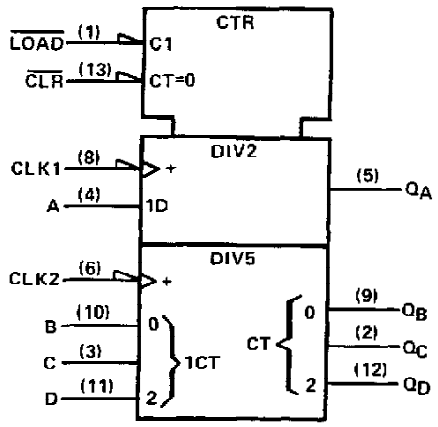
These counters may also be used as 4-bit latches by using the count/load input as the strobe and entering data at the data inputs. The outputs will directly follow the data inputs when the count/load is low, but will remain unchanged when the count/load is high and the clock inputs are inactive.

These high-speed counters will accept count frequencies of 0 to 35 megahertz at the clock-1 input and 0 to 17.5 megahertz at the clock-2 input. During the count operation, transfer of information to the outputs occurs on the negative-going edge of the clock pulse. The counters feature a direct clear which when taken low sets all outputs low regardless of the states of the clocks.

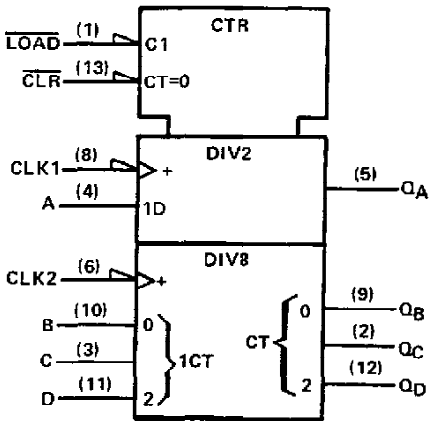
All inputs are diode-clamped to minimize transmission-line effects and simplify system design. The circuits are compatible with most TTL logic families. Typical power dissipation is 150 milliwatts. The SN54176 and SN54177 circuits are characterized for operation over the full military temperature range of −55°C to 125°C; the SN74176 and SN74177 circuits are characterized for operation from 0°C to 70°C.

logic symbols†

'176



'177



† These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

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typical count configurations

SN54176 and SN74176

The output of flip-flop A is not internally connected to the succeeding flip-flops; therefore, the count may be operated in three independent modes:

1. When used as a binary-coded-decimal decade counter, the clock-2 input must be externally connected to the Q_A output. The clock-1 input receives the incoming count, and a count sequence is obtained in accordance with the BCD count sequence function table shown at right.
2. If a symmetrical divide-by-ten count is desired for frequency synthesizers (or other applications requiring division of a binary count by a power of ten), the Q_D output must be externally connected to the clock-1 input. The input count is then applied at the clock-2 input and a divide-by-ten square wave is obtained at output Q_A in accordance with the bi-quinary function table.

FUNCTION TABLES
SN54176, SN74176

DECADE (BCD)
(See Note A)

COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H

BI-QUINARY (5-2)
(See Note B)

COUNT	OUTPUT			
	Q_A	Q_D	Q_C	Q_B
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	H	L	L	L
6	H	L	L	H
7	H	L	H	L
8	H	L	H	H
9	H	H	L	L

H = high level, L = low level

NOTES: A. Output Q_A connected to clock-2 input.
B. Output Q_D connected to clock-1 input.

3. For operation as a divide-by-two counter and a divide-by-five counter, no external interconnections are required. Flip-flop A is used as a binary element for the divide-by-two function. The clock-2 input is used to obtain binary divide-by-five operation at the Q_B, Q_C, and Q_D outputs. In this mode, the two counters operate independently; however, all four flip-flops are loaded and cleared simultaneously.

SN54177 and SN74177

The output of flip-flop A is not internally connected to the succeeding flip-flops, therefore the counter may be operated in two independent modes:

1. When used as a high-speed 4-bit ripple-through counter, output Q_A must be externally connected to the clock-2 input. The input count pulses are applied to the clock-1 input. Simultaneous divisions by 2, 4, 8, and 16 are performed at the Q_A, Q_B, Q_C, and Q_D outputs as shown in the function table at right.
2. When used as a 3-bit ripple-through counter, the input count pulses are applied to the clock-2 input. Simultaneous frequency divisions by 2, 4, and 8 are available at the Q_B, Q_C, and Q_D outputs. Independent use of flip-flop A is available if the load and clear functions coincide with those of the 3-bit ripple-through counter.

FUNCTION TABLE
SN54177, SN74177
(See Note A)

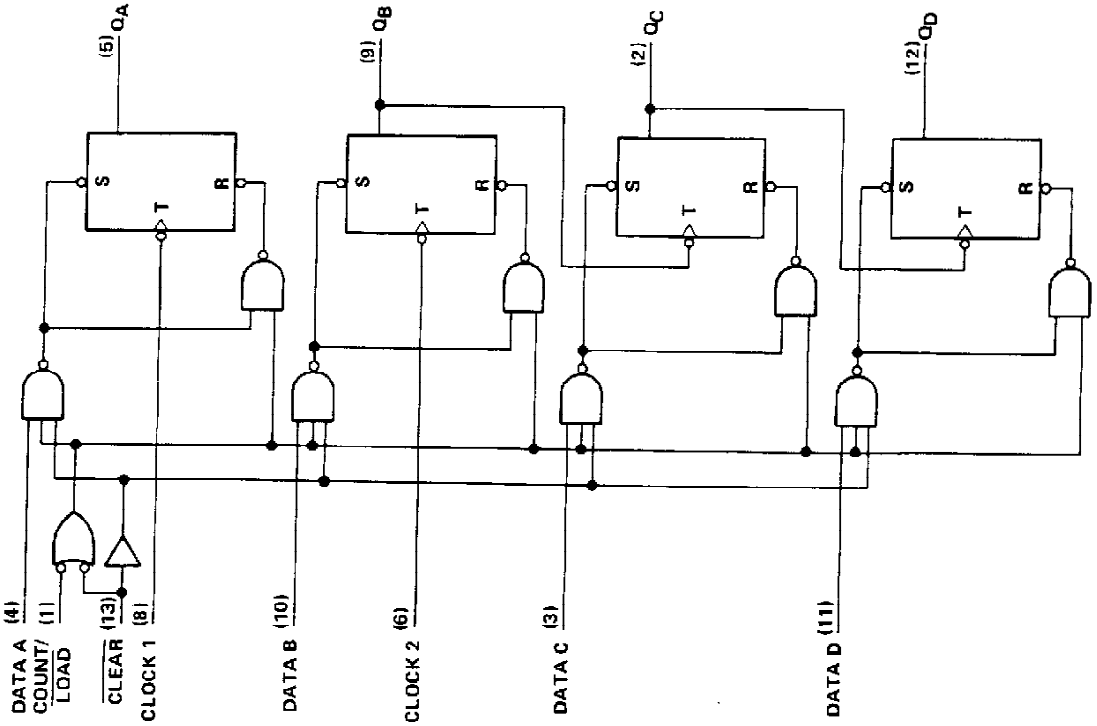
COUNT	OUTPUT			
	Q_D	Q_C	Q_B	Q_A
0	L	L	L	L
1	L	L	L	H
2	L	L	H	L
3	L	L	H	H
4	L	H	L	L
5	L	H	L	H
6	L	H	H	L
7	L	H	H	H
8	H	L	L	L
9	H	L	L	H
10	H	L	H	L
11	H	L	H	H
12	H	H	L	L
13	H	H	L	H
14	H	H	H	L
15	H	H	H	H

H = high level, L = low level

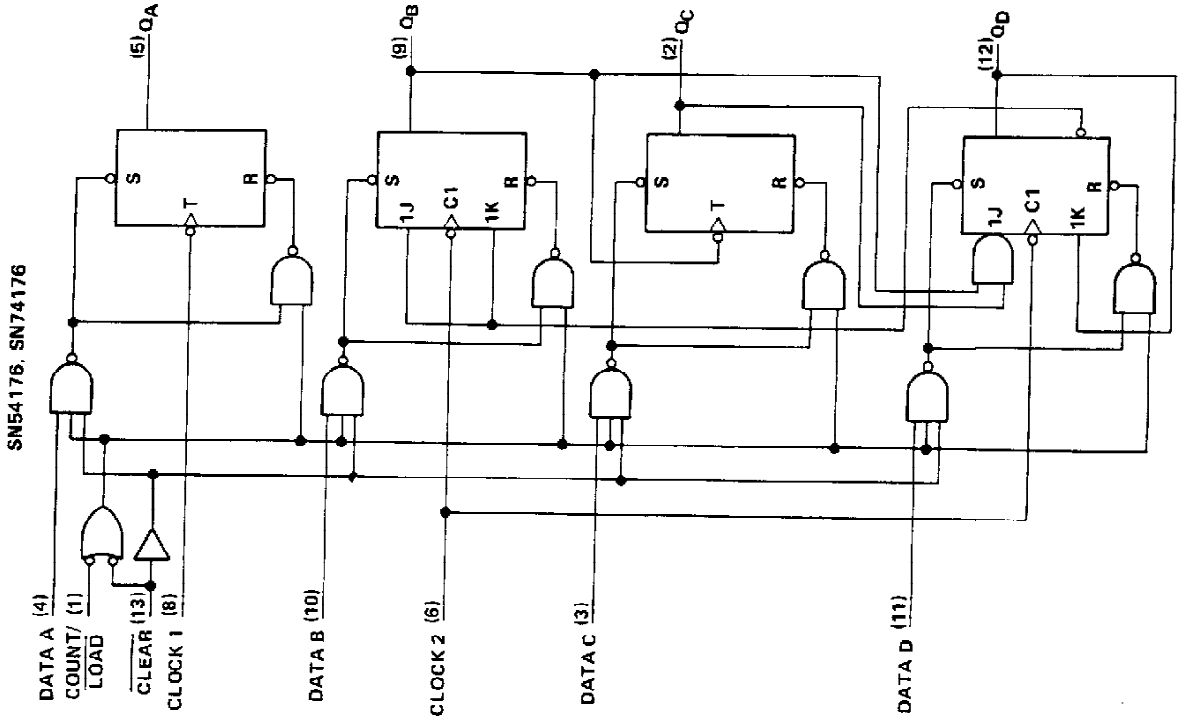
NOTE A: Output Q_A connected to clock-2 input.

logic diagrams (positive logic)

SN54177, SN74177

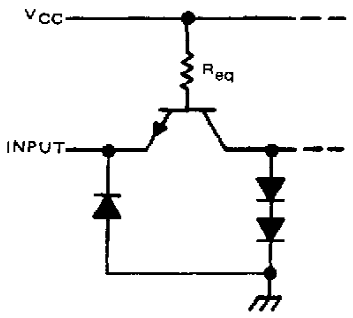


SN54176, SN74176



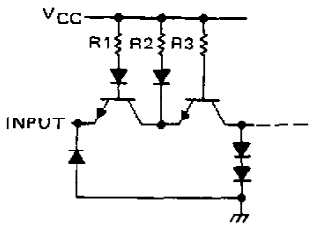
schematics of inputs and outputs

EQUIVALENT OF COUNT/$\overline{\text{LOAD}}$, $\overline{\text{CLEAR}}$, AND DATA INPUTS



Data, Count/$\overline{\text{load}}$: R_{eq} = 4 kΩ NOM
$\overline{\text{Clear}}$: R_{eq} = 2 kΩ NOM

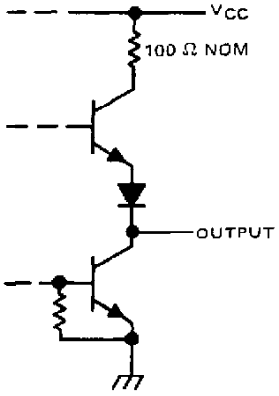
EQUIVALENT OF CLOCK INPUTS



NOMINAL VALUES OF R1, R2, and R3

INPUT	'176	'177
Clock 1	4 kΩ	4 kΩ
Clock 2	4 kΩ	6 kΩ

TYPICAL OF ALL OUTPUTS



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage . . . . . 5.5 V
Interemitter voltage (see Note 2) . . . . . 5.5 V
Operating free-air temperature range: SN54176, SN54177 Circuits . . . . . −55°C to 125°C
SN74176, SN74177 Circuits . . . . . 0°C to 70°C
Storage temperature range . . . . . −65°C to 150°C

NOTES: 1. Voltage values are with respect to network ground terminal.
2. This is the voltage between two emitters of a multiple-emitter transistor. For this circuit, this rating applies between the clear and count/load inputs.

recommended operating conditions

		MIN	NOM	MAX	UNIT
Supply voltage, V_{CC}	SN54'	4.5	5	5.5	V
	SN74'	4.75	5	5.25	
High-level output current, I_{OH}				−800	μA
Low-level output current, I_{OL}				16	mA
Count frequency (see Figure 1)	Clock-1 input	0		35	MHz
	Clock-2 input	0		17.5	
Pulse width, t_w (see Figure 1)	Clock-1 input	14			ns
	Clock-2 input	28			
	$\overline{\text{Clear}}$	20			
	Load	25			
Input hold time, t_h (see Figure 1)	High-level data	$t_{w(load)}$			ns
	Low-level data	$t_{w(load)}$			
Input setup time, t_{su} (see Figure 1)	High-level data	15			ns
	Low-level data	20			
Count enable time, t_{enable} (see Note 3 and Figure 1)		25			ns
Operating free-air temperature, T_A	SN54'	−55		125	°C
	SN74'	0		70	

NOTE 3: Minimum count enable time is the interval immediately preceding the negative-going edge of the clock pulse during which interval the count/load and clear inputs must both be high to ensure counting.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN54176, SN74176			SN54177, SN74177			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IH}	High-level input voltage				2			2			V
V_{IL}	Low-level input voltage						0.8			0.8	V
V_{IK}	Input clamp voltage		V_{CC} = MIN, I_I = −12 mA				−1.5			−1.5	V
V_{OH}	High-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OH} = −800 μA		2.4	3.4		2.4	3.4		V
V_{OL}	Low-level output voltage		V_{CC} = MIN, V_{IH} = 2 V, V_{IL} = 0.8 V, I_{OL} = 16 mA¶			0.2	0.4		0.2	0.4	V
I_I	Input current at maximum input voltage		V_{CC} = MAX, V_I = 5.5 V				1			1	mA
I_{IH}	High-level input current	Data, count/load	V_{CC} = MAX, V_I = 2.4 V				40			40	μA
		$\overline{\text{Clear}}$, clock 1					80			80	
		Clock 2					120			80	
I_{IL}	Low-level input current	Data, count/load	V_{CC} = MAX, V_I = 0.4 V				−1.6			−1.6	mA
		$\overline{\text{Clear}}$					−3.2			−3.2	
		Clock 1					−4.8			−4.8	
		Clock 2					−4.8			−3.2	
I_{OS}	Short-circuit output current§		V_{CC} = MAX	SN54'	−20		−57	−20		−57	mA
				SN74'	−18		−57	−18		−57	
I_{CC}	Supply current		V_{CC} = MAX, See Note 4			30	48		30	48	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.
¶ Q_A outputs are tested at I_{OL} = 16 mA plus the limit value of I_{IL} for the clock-2 input. This permits driving the clock-2 input while fanning out to 10 Series 54/74 loads.
NOTE 4: I_{CC} is measured with all inputs grounded and all outputs open.

switching characteristics, V_{CC} = 5 V, R_L = 400 Ω, C_L = 15 pF, T_A = 25°C, see figure 1

PARAMETER#	FROM (INPUT)	TO (OUTPUT)	SN54176, SN74176			SN54177, SN54177			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
f_{max}	Clock 1	Q_A	35	50		35	50		MHz
t_{PLH}	Clock 1	Q_A		8	13		8	13	ns
t_{PHL}				11	17		11	17	
t_{PLH}	Clock 2	Q_B		11	17		11	17	ns
t_{PHL}				17	26		17	26	
t_{PLH}	Clock 2	Q_C		27	41		27	41	ns
t_{PHL}				34	51		34	51	
t_{PLH}	Clock 2	Q_D		13	20		44	66	ns
t_{PHL}				17	26		50	75	
t_{PLH}	A, B, C, D	Q_A, Q_B, Q_C, Q_D		19	29		19	29	ns
t_{PHL}				31	46		31	46	
t_{PLH}	Load	Any		29	43		29	43	ns
t_{PHL}				32	48		32	48	
t_{PHL}	$\overline{\text{Clear}}$	Any		32	48		32	48	ns

f_{max} = maximum count frequency.
t_{PLH} = propagation delay time, low-to-high-level output.
t_{PHL} = propagation delay time, high-to-low-level output.

PARAMETER MEASUREMENT INFORMATION

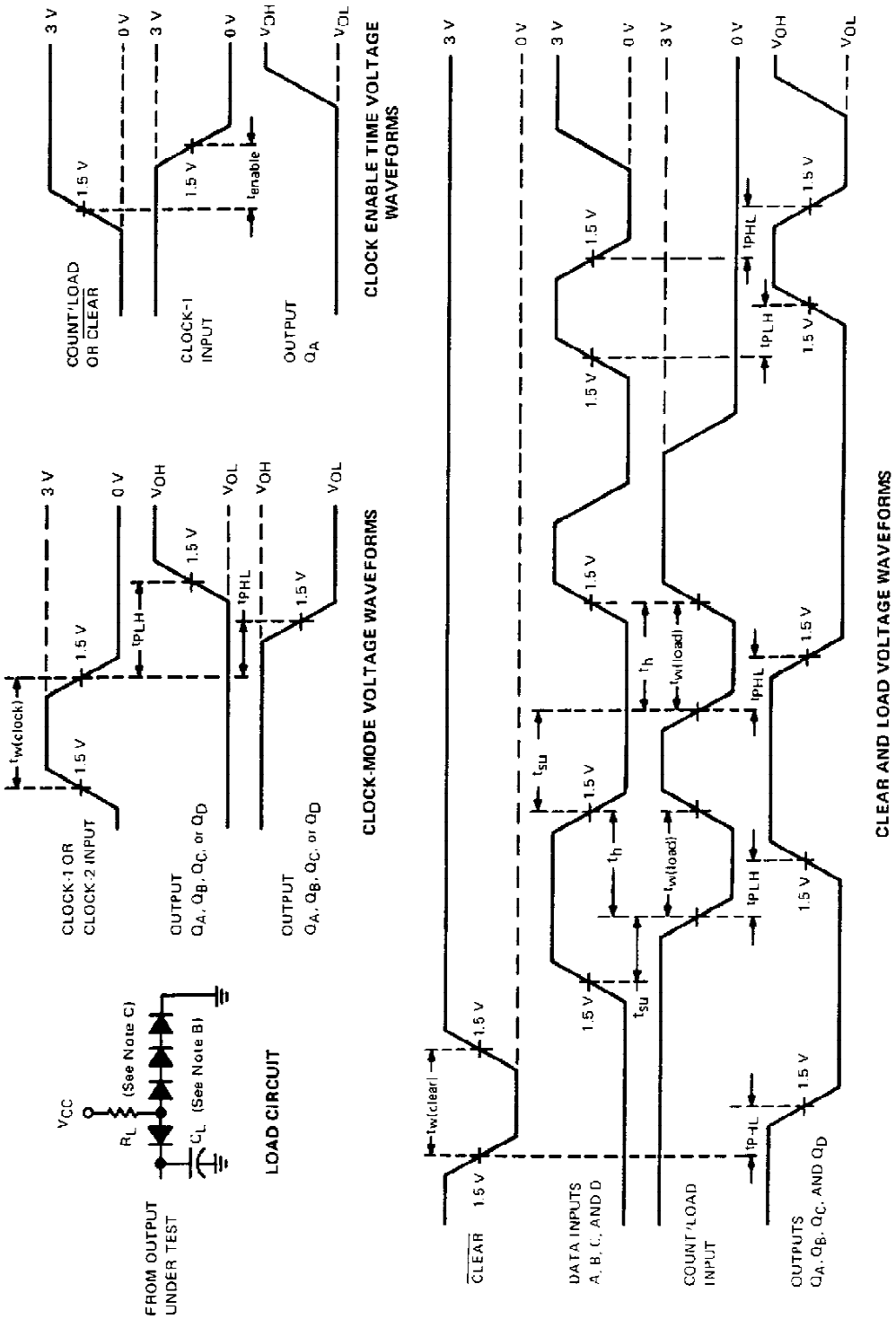


FIGURE 1

NOTES: A. The input pulse is supplied by a generator having the following characteristics: PRR ≤ 1 MHz, duty cycle ≤ 50%, t_r < 5 ns, and unless specified, t_f < 5 ns. When testing f_{max}, vary PRR.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N3064 or equivalent.
D. Unless otherwise specified, Q_A is connected to clock 2.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
SN54176J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74177N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SN74177N	OBSOLETE	PDIP	N	14		TBD	Call TI	Call TI
SNJ54176J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SNJ54176J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI

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NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
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OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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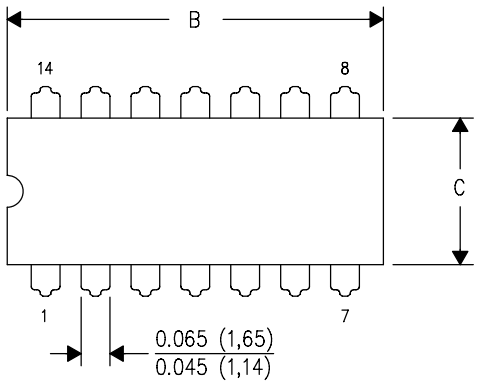
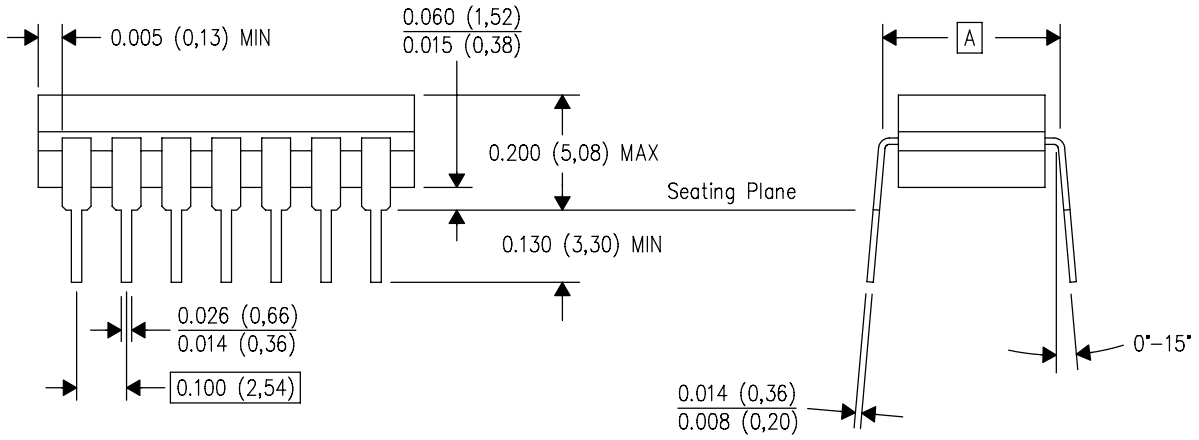
J (R–GDIP–T**)

14 LEADS SHOWN

CERAMIC DUAL IN–LINE PACKAGE



DIM \ PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	—	—	—	—
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)



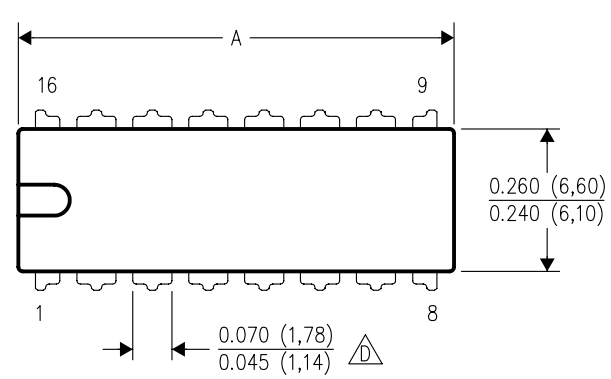
4040083/F 03/03

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. This package is hermetically sealed with a ceramic lid using glass frit.
D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
E. Falls within MIL STD 1835 GDIP1–T14, GDIP1–T16, GDIP1–T18 and GDIP1–T20.

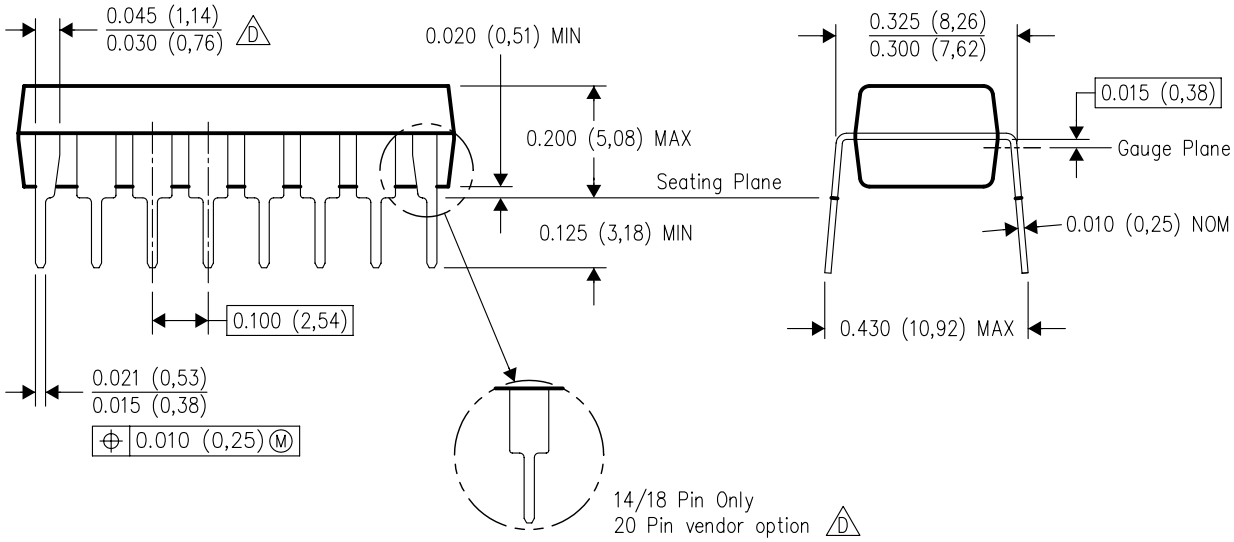
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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